

CAN-Transceiver

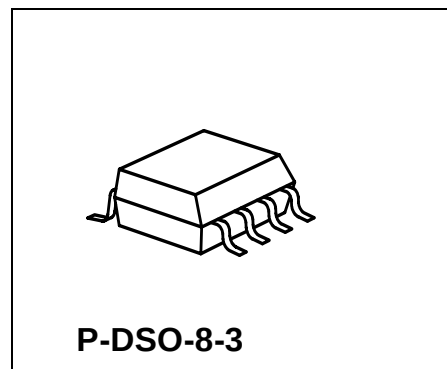
TLE 6250

Target Data Sheet

1 Overview

1.1 Features

- CAN data transmission rate up to 1 Mbaud
- Compatible to ISO/DIS 11898
- Suitable for 12 V and 24 V applications
- Wide common mode range for immunity to EMI
- Version for 5V and 3.3V micro controllers
- No reverse currents from bus via an unpowered node
- Short circuit proof to ground and battery
- Overtemperatur protection



Type	Ordering Code	Package
TLE 6250 G	on request	P-DSO-8-3
TLE 6250 G V33	on request	P-DSO-8-3

Description

The CAN-transceiver TLE 6250 is a monolithic integrated circuit in a P-DSO-8-3 package for high speed differential mode data transmission in automotive and industrial applications. It works as an interface between the CAN protocol controller and the physical differential bus in both, 12 V and 24 V systems.

There are two versions available: one for 5 V logic and the other one for 3.3 V logic requiring additional supply via the V_{33V} pin. The IC can be set to stand-by mode via a control input.

The IC is based on the Siemens Power Technology SPT® which allows bipolar and CMOS control cricuity in accordance with DMOS power devices existing on the same monolithic circuitry.

The TLE 6250 is designed to withstand the severe conditions of automotive applications.

1.2 Pin Configuration (top view)

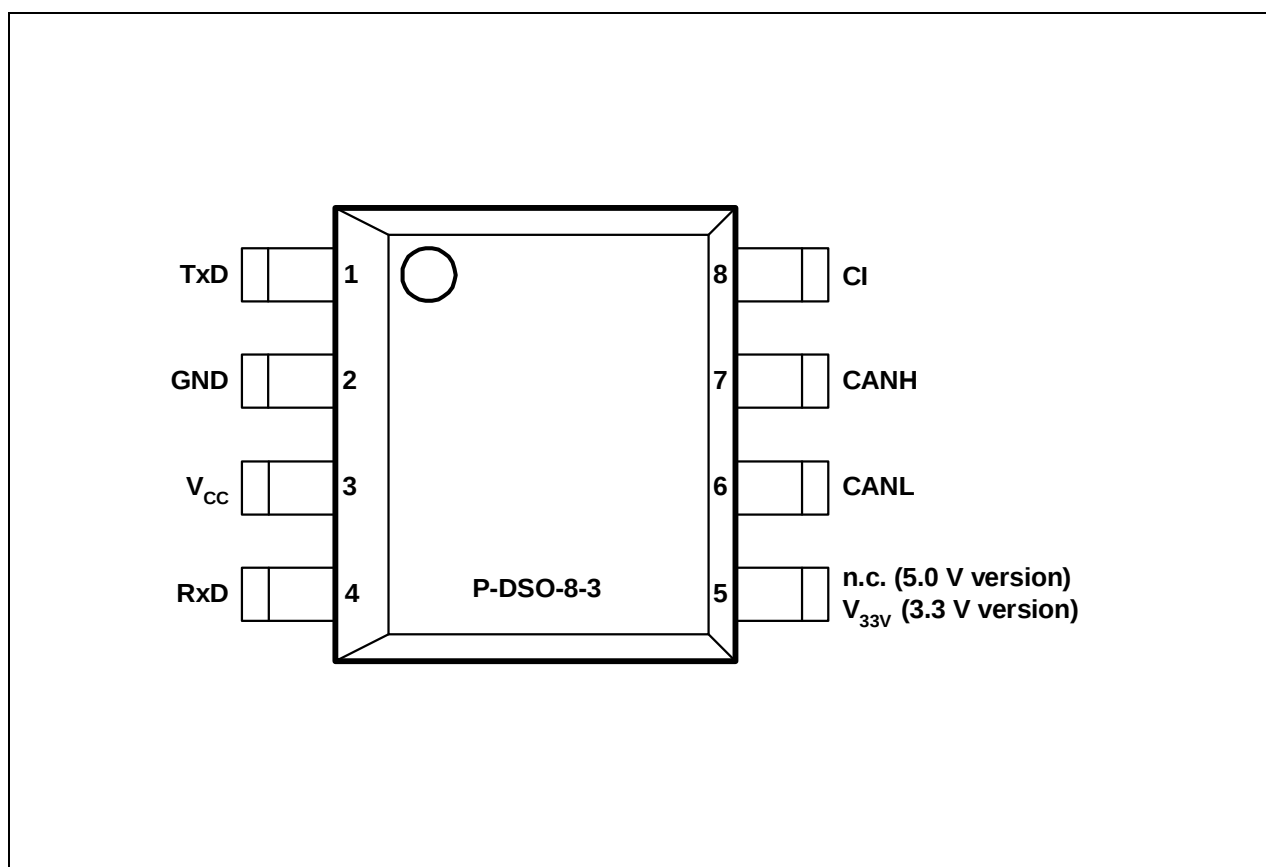


Figure 1

1.3 Pin Definitions and Functions

Pin No.	Symbol	Function
1	TXD	CAN transmit data input ; LOW in dominant state
2	GND	Ground ;
3	V _{CC}	5V Supply ;
4	RxD	CAN receive data output ; LOW in dominant state, integrated pull up
5	n.c. V _{33V}	n.c. ; not connected for 5.0 V version 3.3 V logic supply ; (3.3 V version) for applications using 3.3 V microcontroller
6	CANL	Low line input ; LOW in dominant state
7	CANH	High line output ; HIGH in dominant state
8	CI	Control input ; set HIGH for stand-by mode

1.4 Functional Block Diagram

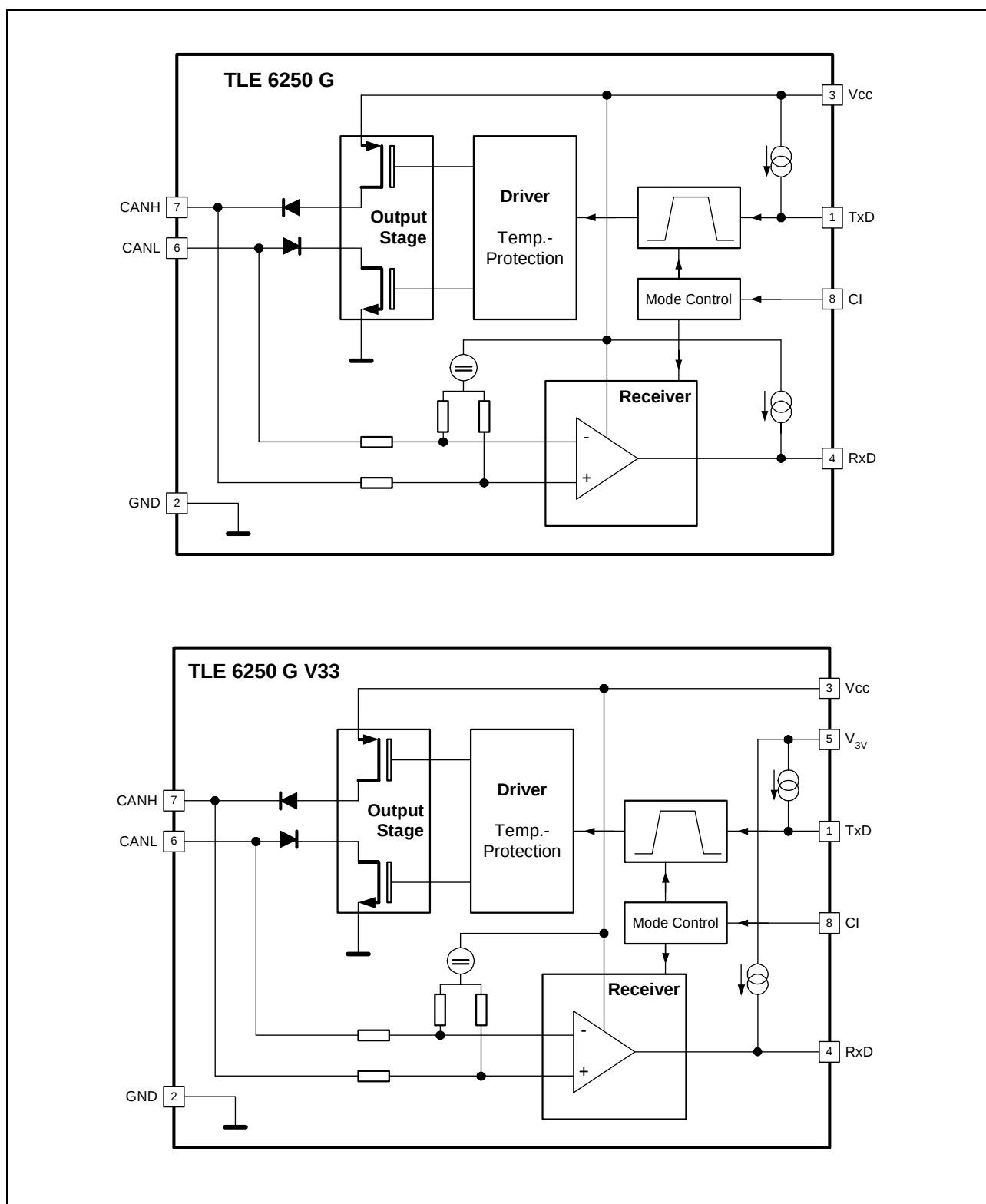


Figure 2

2 Electrical Characteristics

2.1 Absolute Maximum Ratings

Parameter	Symbol	Limit Values		Unit	Remarks
		min.	max.		

Voltages

Supply voltage	V_{CC}	-0.3	6	V	
3.3V supply	V_{33V}	-0.3	6	V	3.3 V version
CAN input voltage (CANH, CANL)	$V_{CANH/L}$	-20	40	V	
Logic voltages at CI, TxD, RxD	V_I	-0.3	$V_{CC} + 0.3$	V	$0\text{ V} < V_{CC} < 5.5\text{ V}$
Electrostatic discharge voltage	V_{ESD}	-2	2	kV	human body model (100 pF via 1.5 kΩ)

Currents

Temperatures

Junction temperature	T_j	-40	150	°C	–
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Note: Maximum ratings are absolute ratings; exceeding any one of these values may cause irreversible damage to the integrated circuit.

2.2 Operating Range

Parameter	Symbol	Limit Values		Unit	Remarks
		min.	max.		
Supply voltage	V_{CC}	4.5	5.5	V	
3V supply voltage	V_{33V}	3.0	3.6	V	3.3 V version
Junction temperature	T_j	– 40	150	°C	–

Thermal Resistances

Junction ambient	R_{thj-a}	–	200	K/W	–
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2.3 Electrical Characteristics

4.5 V < V_{CC} < 5.5 V; (3.0 V < V_{33V} < 3.6 V for 3.3 V version); $R_L = 60 \Omega$; $V_{CI} > V_{CI,ON}$; $-40^\circ\text{C} < T_j < 150^\circ\text{C}$; all voltages with respect to ground; positive current flowing into pin; unless otherwise specified.

Parameter	Symbol	Limit Values			Unit	Test Condition
		min.	typ.	max.		

Current Consumption

Current consumption	I_{CC}			15	mA	recessive state; $V_{TXD} = 4 \text{ V}$
Current consumption	I_{CC}			80	mA	dominant state; $V_{TXD} = 1 \text{ V}$
Current consumption	I_{33V}			2	mA	(3.3V version only)
Current consumption	$I_{CC, stb}$		200		μA	stand-by mode
Current consumption	$I_{CC+33V, stb}$		200		μA	stand-by mode (3.3V version only)

Receiver Output RxD

HIGH level output voltage $V_{diff} = V_{CANH} - V_{CANL}$	V_{OH}	$0.8 \times V_{CC}$		V_{CC}	V	$I_{RX} = -300 \mu\text{A}$; $V_{diff} < 0,4 \text{ V}$
		$0.9 \times V_{33V}$		V_{33V}	V	3.3 V version $I_{RX} = -300 \mu\text{A}$; $V_{diff} < 0,4 \text{ V}$
LOW level output voltage $V_{diff} = V_{CANH} - V_{CANL}$	V_{OL}	0		$0.2 \times V_{CC}$	V	$I_{RX} = 1 \text{ mA}$; $V_{diff} > 1 \text{ V}$
		0		$0.2 \times V_{33V}$	V	3.3 V version $I_{RX} = 1 \text{ mA}$; $V_{diff} > 1 \text{ V}$

Bus receiver

Differential receiver threshold voltage $V_{diff} = V_{CANH} - V_{CANL}$	V_{diff}	$0.1 \times V_{CC}$		$0.18 \times V_{CC}$	V	$-2 \text{ V} < (V_{CANH}, V_{CANL}) < 7 \text{ V}$
Differential receiver hysteresis	$V_{diff} \text{ (hys)}$		200		mV	
CANH, CANL input resistance	R_i		20		$k\Omega$	recessive state
Differential input resistance	R_{diff}		40		$k\Omega$	recessive state

2.3 Electrical Characteristics (cont'd)

4.5 V < V_{CC} < 5.5 V; (3.0 V < V_{33V} < 3.6 V for 3.3 V version); $R_L = 60 \Omega$; $V_{CI} > V_{CI,ON}$; $-40^\circ\text{C} < T_j < 150^\circ\text{C}$; all voltages with respect to ground; positive current flowing into pin; unless otherwise specified.

Parameter	Symbol	Limit Values			Unit	Test Condition
		min.	typ.	max.		

Transmission Input TxD

HIGH level input voltage threshold	V_{IH}	$0.7 \times V_{CC}$	—	$V_{CC} + 0.3$	V	recessive state; 5.0 V version
		$0.7 \times V_{33V}$	—	$V_{33V} + 0.3$	V	recessive state; 3.3 V version
LOW level input voltage threshold	V_{IL}	-0.3	—	$0.3 \times V_{CC}$	V	dominant state
		-0.3	—	$0.3 \times V_{33V}$	V	dominant state 3.3 V version
HIGH level input current	I_{IH}	-200		-30	μA	$V_{TxD} = 4 \text{ V}$
LOW level input current	I_{IL}	-800		-100	μA	$V_{TxD} = 1 \text{ V}$

Bus transmitter

CANL/CANH recessive output voltage	$V_{CANL/H}$	$0.4 \times V_{CC}$		$0.6 \times V_{CC}$	V	$V_{TxD} = 4 \text{ V}$;
CANH, CANL recessive output voltage difference $V_{bus\Delta} = V_{CANH} - V_{CANL}$	$V_{bus\Delta}$	-500		50	mV	$V_{TxD} = 4 \text{ V}$;
CANL dominant output voltage	V_{CANL}			2.0	V	$V_{TxD} = 1 \text{ V}$;
CANH dominant output voltage	V_{CANH}	3.0			V	$V_{TxD} = 1 \text{ V}$; $4.75 \text{ V} < V_{CC} < 5.5 \text{ V}$
CANH, CANL dominant output voltage difference $V_{bus\Delta} = V_{CANH} - V_{CANL}$	$V_{bus\Delta}$	1.5		3.0	V	$V_{TxD} = 1 \text{ V}$; $4.75 \text{ V} < V_{CC} < 5.5 \text{ V}$
CANL short circuit current	I_{CANLsc}		140		mA	$V_{CANLshort} = 18 \text{ V}$
			180		mA	$V_{CANLshort} = 36 \text{ V}$
CANH short circuit current	I_{CANHsc}		-140		mA	$V_{CANLshort} = -5 \text{ V}$

2.3 Electrical Characteristics (cont'd)

4.5 V < V_{CC} < 5.5 V; (3.0 V < V_{33V} < 3.6 V for 3.3 V version); $R_L = 60 \Omega$; $V_{CI} > V_{CI,ON}$; $-40^\circ\text{C} < T_j < 150^\circ\text{C}$; all voltages with respect to ground; positive current flowing into pin; unless otherwise specified.

Parameter	Symbol	Limit Values			Unit	Test Condition
		min.	typ.	max.		
CANH leakage current	I_{CANHI}	-10			μA	$V_{CC} = 0 \text{ V}$, $-2 \text{ V} < V_{CANH} < 7 \text{ V}$, $T_j < 85^\circ\text{C}$
CANL leakage current	I_{CANLI}			10	μA	$V_{CC} = 0 \text{ V}$, $-2 \text{ V} < V_{CANL} < 7 \text{ V}$, $T_j < 85^\circ\text{C}$

Mode control input (pin CI)

High input voltage	$V_{CI,ON}$	0.75x V_{CC}			V	stand-by mode
High input current	$I_{CI,ON}$		5		μA	stand-by mode

Dynamic CAN-Transceiver Characteristics

Propagation delay TxD-to-RxD LOW (recessive to dominant)	$t_{d(L),TR}$		150	280	ns	$C_L = 47\text{pF}$; $R_L = 60\Omega$; $V_{CC} = 5\text{V}$; $C_{RxD} = 20\text{pF}$
Propagation delay TxD-to-RxD HIGH (dominant to recessive)	$t_{d(H),TR}$		150	280	ns	$C_L = 47 \text{ pF}$; $R_L = 60 \Omega$; $V_{CC} = 5 \text{ V}$; $C_{RxD} = 20\text{pF}$
Propagation delay TxD LOW to bus dominant	$t_{d(L),T}$		50		ns	$C_L = 47 \text{ pF}$; $R_L = 60 \Omega$; $V_{CC} = 5 \text{ V}$
Propagation delay TxD HIGH to bus recessive	$t_{d(H),T}$		50		ns	$C_L = 47 \text{ pF}$; $R_L = 60 \Omega$; $V_{CC} = 5 \text{ V}$
Propagation delay bus dominant to RxD LOW	$t_{d(L),R}$		100		ns	$C_L = 47 \text{ pF}$; $R_L = 60 \Omega$; $V_{CC} = 5\text{V}$; $C_{RxD} = 20\text{pF}$
Propagation delay bus recessive to RxD HIGH	$t_{d(H),R}$		100		ns	$C_L = 47 \text{ pF}$; $R_L = 60 \Omega$; $V_{CC} = 5 \text{ V}$; $C_{RxD} = 20\text{pF}$

Thermal Shutdown (junction temperature)

Thermal shutdown temp.	T_{jSD}	150	170	185	$^\circ\text{C}$	–
Thermal shutdown hyst.	ΔT	–	10	–	K	–

3 Diagrams

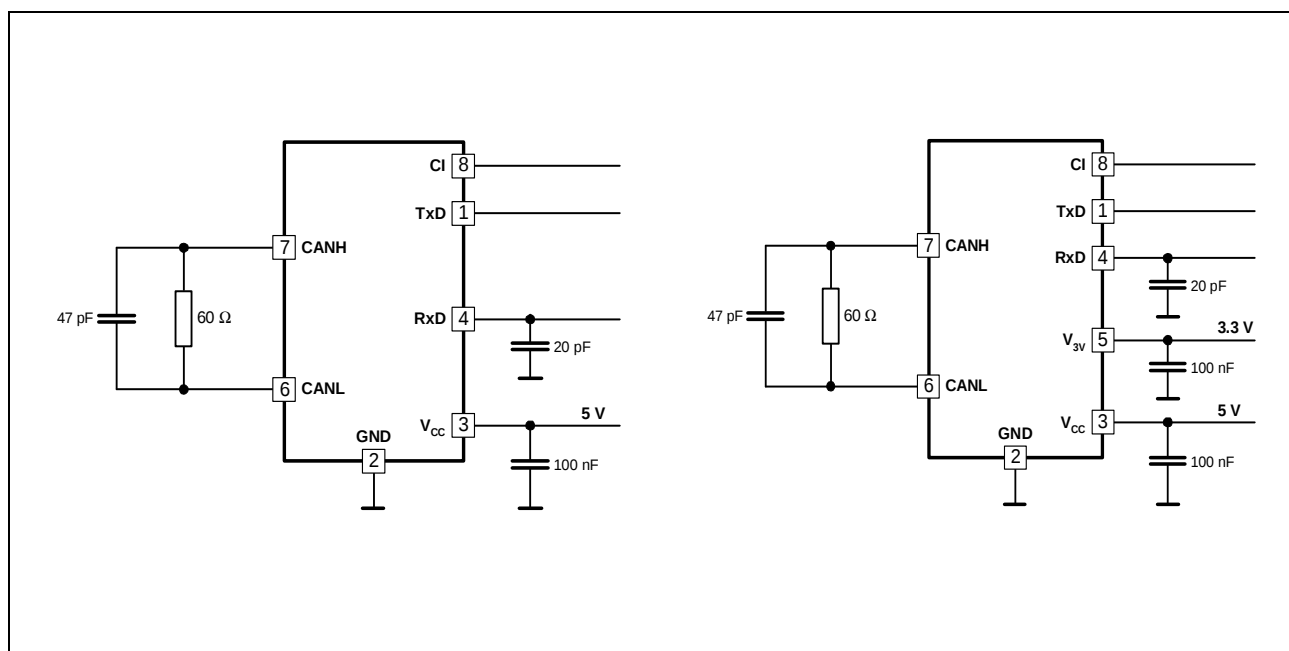


Figure 3: Test circuits

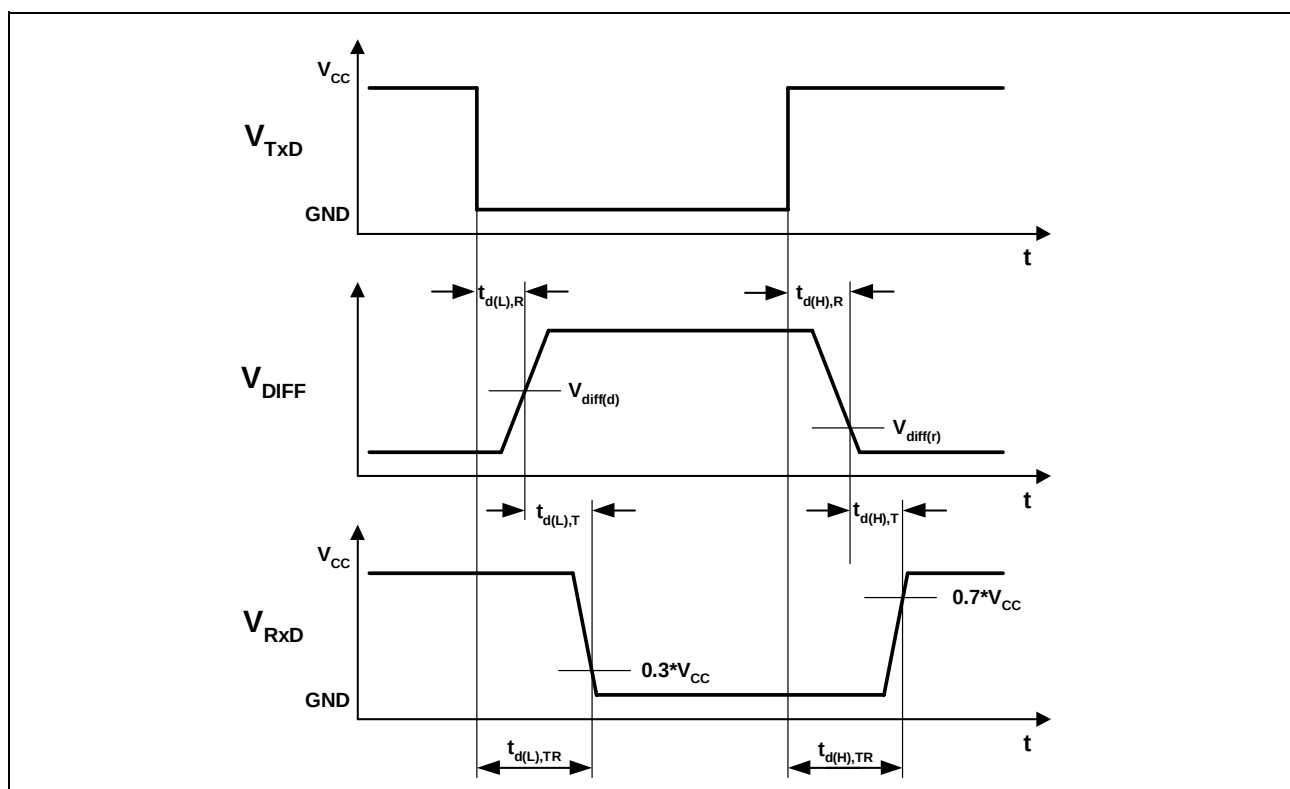


Figure 4: Timing diagrams for dynamic characteristics

4 Application

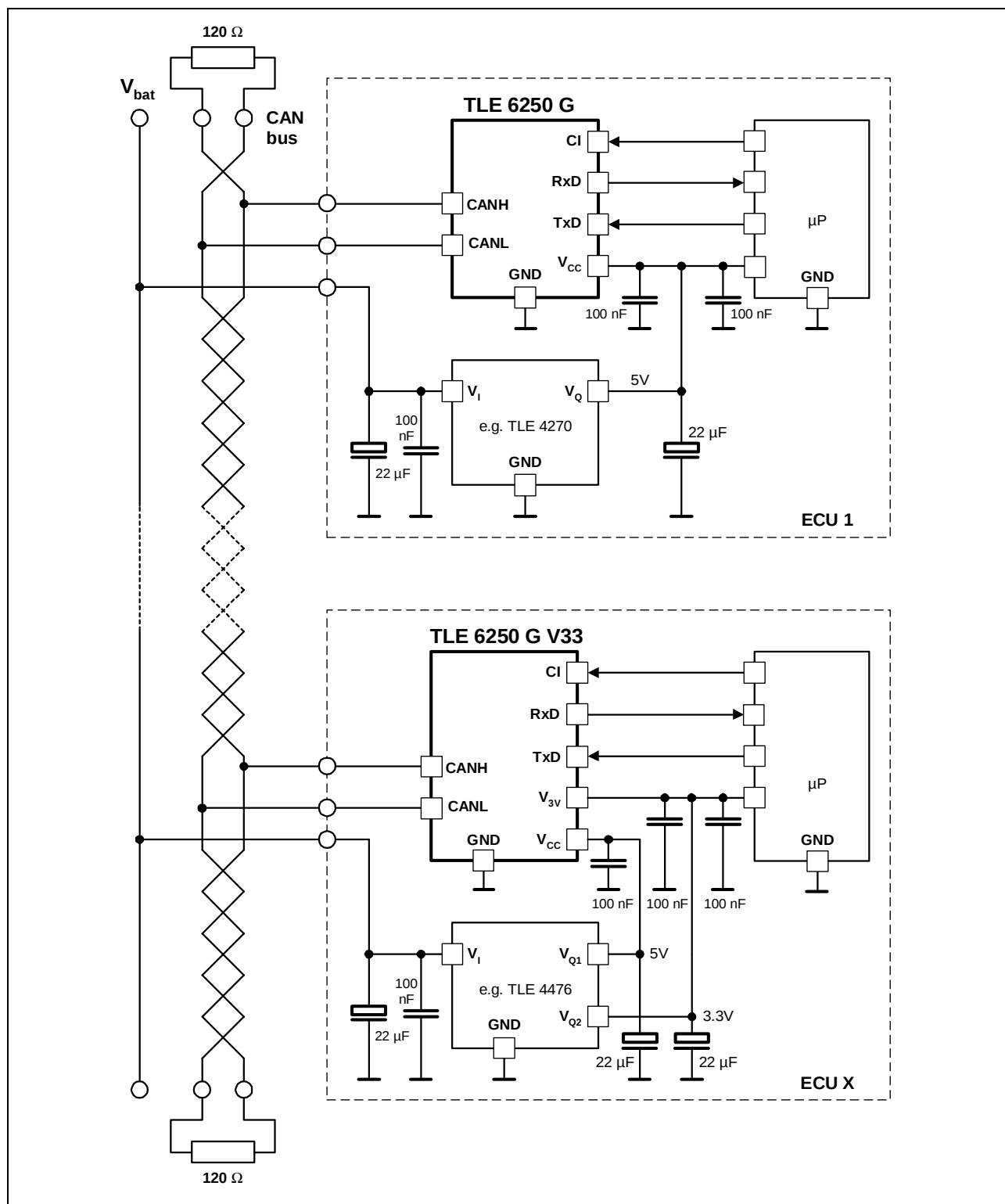
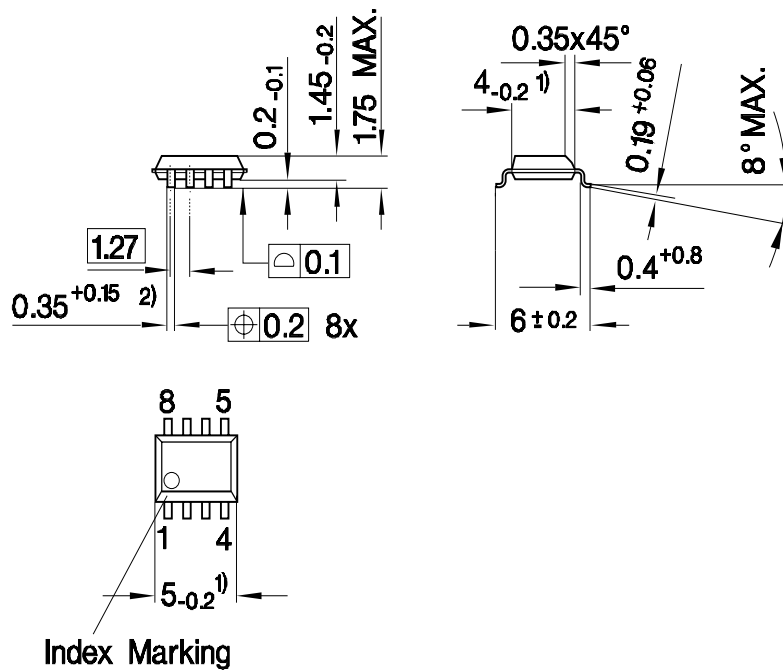


Figure 5
Application Circuit

5 Package Outlines

P-DSO-8-3

(Plastic Dual Small Outline Package)



Index Marking

- 1) Does not include plastic or metal protrusion of 0.15 max. per side
- 2) Lead width can be 0.61 max. in dambar area

Sorts of Packing

Package outlines for tubes, trays etc. are contained in our Data Book "Package Information".

SMD = Surface Mounted Device

Dimensions in mm